



# Quartz Crystal Specification CX3 EXT

#### ISSUE 1; January 2016

#### Description

- The CX3 EXT surface-mount quartz crystal is hermetically sealed in a rugged ceramic package. This crystal has been designed utilising the experience acquired by producing millions of crystals for industrial, commercial, military and medical applications.
- -C SM1 Gold plated (lead free) ceramic lid
- -C SM4 Solder plated (lead free) ceramic lid
- -C SM5 Solder dipped (lead free) ceramic lid
- -SM1 Gold plated (lead free) glass lid
- -SM4 Solder plated (lead free) glass lid
- -SM5 Solder dipped (lead free) glass lid
- FEATURES:

Extensional mode

Ideal for use with microprocessors

Designed for low power applications

Compatible with hybrid or PC board packaging

Low ageing

Full military testing available

Ideal for battery operated applications

- TYPICAL APPLICATION FOR A PIERCE OSCILLATOR:
  The low profile CX3 EXT miniature surface mount crystal is ideal for small, high density, battery operated portable products. The CX crystal designed in a Pierce oscillator (single inverter) circuit provides very low current consumption and high stability.
- A conventional CMOS Pierce oscillator circuit is shown. The
  crystal is effectively inductive and in a PI network circuit with
  CD and CG provides the additional phase shift necessary to
  sustain oscillation. The oscillation
  frequency (f0) is 15 to 150 ppm above the crystal's series
  resonant frequency (fS).
- Drive Level:

RA is used to limit the crystal's drive level by forming a voltage divider between RA and CD. RA also stabilizes the oscillator against changes in the amplifiers output resistance (R0). RA should be increased for higher voltage operation.

- Load Capacitance:
  - The CX3 EXT crystal frequency tolerance is influenced by the effective circuit capacitances, specified as the load capacitance (CL). CL is approximately equal to: CL = ((CD x CG)/(CD + CG)) + CS
- Note: CD and CG include stray layout to ground and CS is the stray shunt capacitance between the crystal terminal. In practice, the effective value of CL will be less than that calculated from CD, CG and CS values because of the effect of the amplifier output resistance. CS should be minimized.
- The oscillation frequency (f0) is approximately equal to:

f0 = fS [1+ (C1/(2\*(C0 + CL))]

Where fS = Series resonant frequency of the crystal

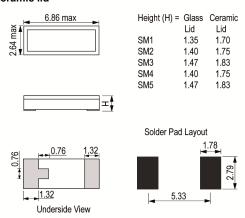
C1 = Motional Capacitance

C0 = Shunt Capacitance

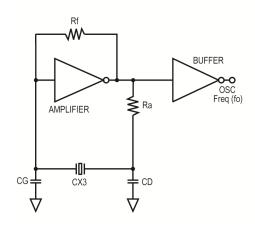
 Please note that all data is only valid at 25°C unless otherwise stated.



## Outline (mm) -C SM1 = Gold plated (lead free) ceramic lid



#### **Conventional CMOS Pierce Oscillator Circuit**



#### Sales Office Contact Details:

UK: +44 (0)1460 270200 Germany: 0800 1808 443 France: 0800 901 383 USA: +1.760.318.2824 Email: info@iqdfrequencyproducts.com Web: www.iqdfrequencyproducts.com





# Quartz Crystal Specification **CX3 EXT**

#### **Frequency Parameters**

Frequency 800.0kHz to 1.35MHz

Frequency Tolerance ±500.00ppm to ±10,000.00ppm

Tolerance Condition @ 25°C

Ageing ±5ppm max in 1st year @ 25°C

■ Turning Point: 35°C standard

Other values are available - please contact an IQD Sales

Office

■ Temperature Coefficient: -0.035ppm/°C² typ

Note: Frequency f at temperature T is related to frequency fo at turning point temperature To by:  $(f-fo)/fo = k(T-To)^2$ 

■ Function Mode: Extensional

Note: Tighter Frequency Tolerances are available - please

contact an IQD Sales Office

#### **Electrical Parameters**

Load Capacitance (CL)
 Shunt Capacitance (C0)
 Drive Level
 7.0pF
 1pF typ
 3µW max

Motional Capacitance: 1.2fF typ

Quality Factor: 150k typ

#### **Operating Temperature Ranges**

■ -10 to 70°C

■ -40 to 85°C

-55 to 125°C

### **Environmental Parameters**

Shock: 1000g, 0.3ms, 1/2 sine

■ Vibration: 10G rms, 20-1000Hz random

Storage Temperature Range: -55 to 125°C

#### **Manufacturing Details**

Maximum Process Temperature: 260°C for 20sec max

#### Ordering Information

■ Frequency\*

Model\*

Lid Variant\*

Termination Variant\*

Frequency Tolerance (@ 25°C)\*

Operating Temperature Range\*

Load Capacitance

(\*minimum required)

■ Lid Variants:

Blank = Glass

C = Ceramic

■ Termination Variants:

SM1 = Gold Plated

SM4 = Solder Plated

SM5 = Solder Dipped

Note: non-RoHS compliant terminations are available - please

contact an IQD Sales Office

Example

1.0MHz CX3 EXT-SM1

1000/-/-40 to 85C/7

#### Compliance

RoHS Status (2011/65/EU) Optional
 REACh Status Compliant
 MSL Rating (JDEC-STD-033): Not Applicable

#### Sales Office Contact Details:

UK: +44 (0)1460 270200 France: 0800 901 383 Germany: 0800 1808 443 USA: +1.760.318.2824





# Quartz Crystal Specification CX3 EXT

### **Packaging Details**

■ Pack Style: Reel Tape & reel in accordance with EIA-481-D

Pack Size: 1,000

■ Pack Style: Tray Supplied on a tray

Pack Size: 1

### **Electrical Specification - maximum limiting values**

Frequency Min	Frequency Max	Temperature Range	Stability (Min)	Over Tone Order	ESR
		°C	ppm		Ω
800.0kHz	1.35MHz	-10 to 70		EXT	5,000
		-40 to 85			
		-55 to 125			

<sup>\*</sup>Stability Maximum values ±0ppm

This document was correct at the time of printing; please contact your local sales office for the latest version. Click to view latest version on our website.

**Sales Office Contact Details:** 

UK: +44 (0)1460 270200 Germany: 0800 1808 443 France: 0800 901 383 USA: +1.760.318.2824 Email: info@iqdfrequencyproducts.com Web: www.iqdfrequencyproducts.com